

Please amend the Abstract to read as follows:

**ABSTRACT OF THE DISCLOSURE**

A polishing slurry for CMP of Cu, which ~~comprises~~ includes a first complexing agent containing a heterocyclic compound which is capable of forming a water-insoluble complex with Cu, and a second complexing agent containing a heterocyclic compound which is capable of forming a slightly water-soluble or water-soluble complex with Cu to thereby provide at least one extra ligand subsequent to formation of the complex.